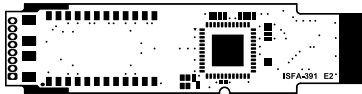
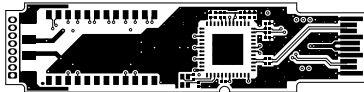


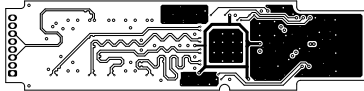
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:ISFA-391	REV:E2	SUN REV: Not in version control
LAYER NAME = Top Paste	TID #: N/A		
PLOT NAME = Top Paste	GENERATED 05.05.202310:02:53	TEXAS INSTRUMENTS	



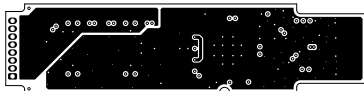
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:ISFA-391	REV:E2	SUN REV: Not in version control
LAYER NAME = Top Solder	TID #: N/A		
PLOT NAME = Top Solder Mask	GENERATED 05.05.202310:02:53	TEXAS INSTRUMENTS	



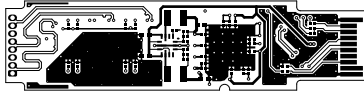
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:ISFA-391	REV:E2	SUN REV: Not in version control
LAYER NAME = L01 - Top Layer	TID #: N/A		
PLOT NAME = L01 - Top Layer	GENERATED 05.05.202310:02:53	TEXAS INSTRUMENTS	



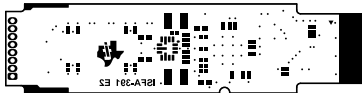
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:ISFA-391	REV:E2	SUN REV: Not in version control
LAYER NAME = L02 - Mid Layer 1	TID #: N/A		
PLOT NAME = L02 - Mid Layer 1	GENERATED 05.05.202310:02:53	TEXAS INSTRUMENTS	



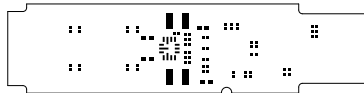
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:ISFA-391	REV:E2	SUN REV: Not in version control
LAYER NAME = L03 - Mid Layer 2	TID #: N/A		
PLOT NAME = L03 - Mid Layer 2	GENERATED 05.05.202310:02:53	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:ISFA-391	REV:E2	SUN REV: Not in version control
LAYER NAME = L04 - Bottom Layer	TID #: N/A		
PLOT NAME = L04 - Bottom Layer	GENERATED 05.05.202310:02:53	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:ISFA-391	REV:E2	SUN REV: Not in version control
LAYER NAME = Bottom Solder	TID #: N/A		
PLOT NAME = Bottom Solder Mask	GENERATED 05.05.202310:02:53	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:ISFA-391	REV:E2	SUN REV: Not in version control
LAYER NAME = Bottom Paste	TID #: N/A		
PLOT NAME = Bottom Paste	GENERATED 05.05.202310:02:53	TEXAS INSTRUMENTS	



Symbol	Quantity	Finished Hole Size	Plated	Hole Type	Drill Layer Pair
V	55	0.100mm (3.94mil)	PTH	Round	LV16A1 L01 - Top Layer - L02 - Mid Layer 1
Ø	16	0.100mm (3.94mil)	PTH	Round	LV16A1 L03 - Mid Layer 2 - L04 - Bottom Layer
○	87	0.200mm (7.87mil)	PTH	Round	L01 - Top Layer - L04 - Bottom Layer
□	8	0.600mm (23.62mil)	PTH	Round	L01 - Top Layer - L04 - Bottom Layer
156 Total					

Symbol	Count	Hole Size	Plated	Hole Type	Drill Layer Pair	Via/Pad
□	55	0.100mm (3.94mil)	PTH	Round	LV16A1 L01 - Top Layer - L02 - Mid Layer 1	Via
55 Total						

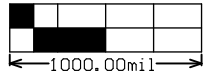
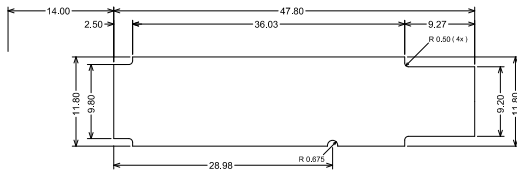
Symbol	Count	Hole Size	Plated	Hole Type	Drill Layer Pair	Via/Pad
Ø	16	0.100mm (3.94mil)	PTH	Round	LV16A1 L03 - Mid Layer 2 - L04 - Bottom Layer	Via
16 Total						



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:ISFA-391	REV:E2	SUN REV: Not in version control
LAYER NAME = Drill Drawing	TID #: N/A		
PLOT NAME = Drill Drawing	GENERATED 05.05.2023 10:02:53	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:ISFA-391	REV:E2	SUN REV: Not in version control
LAYER NAME = M3 Milling Board CutOuts	TID #: N/A		
PLOT NAME = Board Milling	GENERATED 05.05.202310:02:54	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:ISFA-391	REV:E2	SUN REV: Not in version control
LAYER NAME = M2 Board Dimensions	TID #: N/A		
PLOT NAME = Board Dimensions	GENERATED 05.05.202310:02:54	TEXAS INSTRUMENTS	

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